



Uncooled LWIR OEM Thermal Camera Module

# **BOSON**®

Made in the USA, and ITAR-free, the Boson longwave infrared (LWIR) OEM thermal camera module set the standard for size, weight, power, and performance (SWaP). Utilizing Teledyne FLIR's advanced image processing and several industry-standard communication interfaces, Boson enables applications from firefighting to unmanned aircraft systems (UAS), security, and automotive development kits, all for as little as 600 mW.

The 12  $\mu$ m uncooled detector comes in two resolutions – 640 x 512 or 320 x 256 – and multiple frame rate options. Radiometric models offer absolute temperature measurement. With multiple lens configurations also available, Boson offers the widest range of LWIR models from Teledyne FLIR and the most flexibility to integration programs. The easy-to-use Boson SDK, user-friendly GUI, and comprehensive product integration documentation further simplify OEM integrated into higher-level systems.

For a plug-and-play sensitivity upgrade, the new Boson+, provides an industry-leading NeDT of <20 mK.



### INDUSTRY-LEADING SIZE, WEIGHT, AND POWER (SWAP) WITH RADIOMETRY

A full-featured VGA and QVGA LWIR thermal camera modules starting at 7.5 grams and <4.9 cm<sup>3</sup>.

- Low power consumption, starting at 600 mW
- 640 and 320 resolutions, 12 µm pixel pitch radiometric LWIR microbolometer
- Rugged construction and stable operation across temperature rating of -40 °C to 80 °C



# PROVEN PERFORMANCE AND WIDELY DEPLOYED

Consistent performance, flexibility, and availability of the widest range of LWIR model configurations from Teledyne FLIR.

- High volume manufacturing with offthe-shelf availability
- Accessible third-party accessory kits from numerous third parties
- Adapt performance to use conditions through both hardware and software configurations

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## DESIGNED FOR INTEGRATORS

Shared mechanical/electrical compatibility across all Boson provides plug-and-play with existing designs.

- Easy-to-use Boson SDK, user-friendly GUI, and comprehensive product integration documentation
- Highly qualified Technical Services team available to support integration
- Manufactured in the USA and classified under US Department of Commerce jurisdiction as EAR 6A003.b.4.b

For more information visit: www.flir.com/boson

## www.teledyneflir.com

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#### SPECIFICATIONS

| Thermal Imager   | Boson   |              |
|--|---|--------------|
| Array Format   | 320 x 256 or 640 x 512  |              |
| Pixel Pitch  | 12 µm   |              |
| Thermal Spectral Range                                     | Longwave infrared; 8 µm – 14 µm   |              |
| Thermal Sensitivity  | <40 mK (Industrial)<br><50 mK (Professional)<br><60 mK (Consumer)   |              |
| Radiometric Temperature Measurement                        | Available in some models  |              |
| Full Frame Rate, Slow Frame Rate                           | 60 Hz baseline; 30 Hz runtime selectable, <9 Hz available   |              |
| Non-uniformity Correction (NUC)                            | Factory calibrated; updated FFCs with FLIR Silent Shutterless NUC (SSN $^{\!$ |              |
| Solar Protection   | Integral  |              |
| Digital Zoom   | 1x to 8x zoom   |              |
| Symbol Overlay   | Re-writable each frame; alpha blending for translucent overlay  |              |
| Lens Options   |   |              |
| Array Format   | 320 × 256   | 640 × 512    |
| Horizontal Field of View (HFOV);<br>Effective Focal Length | 92°; 2.3 mm   | 95°; 4.9 mm  |
|  | 50°; 4.3 mm   | 50°; 8.7 mm  |
|  | 34°; 6.3 mm   | 50°; 9.2 mm  |
|  | 24°; 9.1 mm   | 32°; 13.6 mm |
|  | 16°; 14 mm  | 32°; 14 mm   |
|  | 12°; 18 mm  | 24°; 18 mm   |
|  | 6°; 36 mm   | 18°; 24 mm   |
|  | 4°; 55 mm   | 12°; 36 mm   |
|  |   | 8°; 55 mm    |
|  |   | 6°; 73 mm    |
| Physical Attributes  |   |              |
| Size   | 21 × 21 × 11 mm (0.83 × 0.83 × 0.43 in) without lens  |              |
| Weight   | 7.5 g (0.26 oz) without lens  |              |
| Precision Mounting Holes                                   | Four tapped M1.6x0.35 (rear cover)  |              |
| Interfacing  |   |              |
| Input Voltage  | 3.3 VDC   |              |
| Power Dissipation  | Varies by configuration; as low as 500 mW   |              |
| Video Channels   | CMOS or USB-2   |              |
| Control Channels   | UART or USB   |              |
| Configurable GPIO  | Up to 11; user configurable   |              |
| Environmental  |   |              |
| Operating Temperature Range                                | -40 °C to 80 °C (-40 °F to 176 °F)  |              |
| Non-Operating Temperature Range                            | -50 °C to 85 °C (-58 °F to 185 °F)  |              |
| Shock  | 1,500 g @ 0.4 msec  |              |
| Operational Altitude                                       | 12,192 m (40,000 ft)<br>(max altitude of a commercial airliner or airborne platform)  |              |

Specifications are subject to change without notice. For the most up-to-date specs, go to www.flir.com/boson

SANTA BARBARA

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